# **Surface Mount Schottky Power Rectifier**

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system.

#### **Features**

- Low Profile Package for Space Constrained Applications
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- 150°C Operating Junction Temperature
- Guard-Ring for Stress Protection
- These are Pb-Free and Halide-Free Devices

#### **Mechanical Charactersistics**

- Case: Epoxy, Molded, Epoxy Meets UL 94, V-0
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Cathode Polarity Band
- Device Meets MSL 1 Requirements
- ESD Ratings: Machine Model = C Human Body Model = 3B



# ON Semiconductor®

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# SCHOTTKY BARRIER RECTIFIER 2.0 AMPERE 100 VOLTS



SMA-FL CASE 403AA STYLE 6

## **MARKING DIAGRAM**



RAA = Specific Device Code A = Assembly Location

Y = Year WW = Work Week ■ = Pb-Free Package

(Note: Microdot may be in either location)

# **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRAF2H100G	SMA-FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
Average Rectified Forward Current (T <sub>L</sub> = 140°C)	I <sub>O</sub>	2.0	Α
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz) T <sub>L</sub> = 145°C	I <sub>FRM</sub>	4.0	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	130	А
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature (Note 1)	T <sub>J</sub>	-65 to +175	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The heat generated must be less than the thermal conductivity from Junction–to–Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

# THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 2)	$\Psi_{JCL}$	TBD	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	TBD	°C/W

<sup>2. 1</sup> inch square pad size (1  $\times$  0.5 inch) for each lead on FR4 board.

## **ELECTRICAL CHARACTERISTICS**

		Val	lue	
Characteristic	Symbol	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	Unit
Maximum Instantaneous Forward Voltage (Note 3) (i <sub>F</sub> = 2.0 A)	VF	0.79	0.65	V
Maximum Instantaneous Reverse Current (Note 3) (V <sub>R</sub> = 100 V)	I <sub>R</sub>	0.050	9.0	mA

<sup>3.</sup> Pulse Test: Pulse Width  $\leq$  380  $\mu$ s, Duty Cycle  $\leq$  2.0%.

## **TYPICAL CHARACTERISTICS**

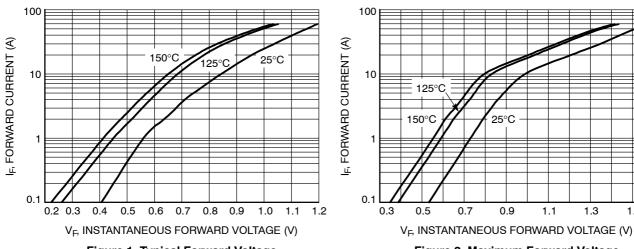


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

1.5

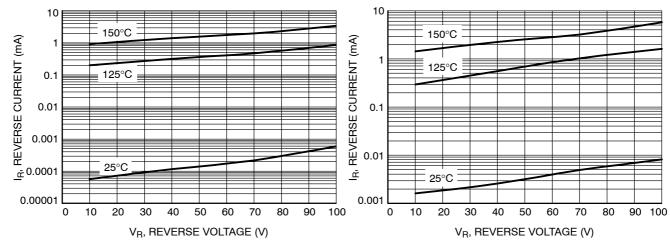


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

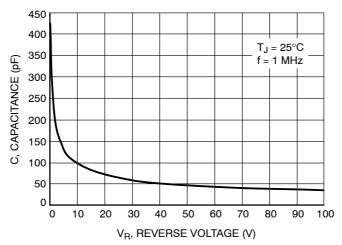


Figure 5. Typical Capacitance

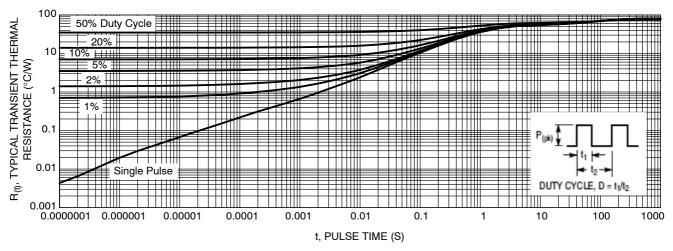
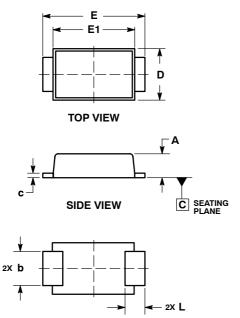


Figure 6. Typical Transient Thermal Response, Junction-to-Ambient

#### PACKAGE DIMENSIONS

## SMA-FL CASE 403AA ISSUE O



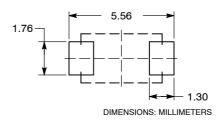
**BOTTOM VIEW** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
- CONTROLLING DIMENSION: MILLIMETERS

	MILLIMETERS	
DIM	MIN	MAX
Α	0.90	1.10
b	1.25	1.65
С	0.15	0.30
D	2.40	2.80
E	4.80	5.40
E1	4.00	4.60
L	0.70	1.10

#### **RECOMMENDED SOLDER FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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